

February 2011 SupreMOS ТМ

# FCA36N60NF **N-Channel MOSFET, FRFET 600V**, **36A**, **95m**Ω

### Features

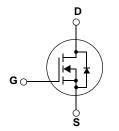
- $R_{DS(on)} = 80m\Omega$  (Typ.)@  $V_{GS} = 10V$ ,  $I_D = 18A$
- Ultra Low Gate Charge (Typ. Qg = 86nC)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- · RoHS Compliant

## Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		Parameter	FCA36N60NF	Units		
V <sub>DSS</sub>	Drain to Source Voltage	600	V			
V <sub>GSS</sub>	Gate to Source Voltage			±30	V	
ID	Drain Current	Continuous ( $T_C = 25^{\circ}C$ )	Continuous ( $T_c = 25^{\circ}C$ )		Δ	
	Drain Current	Continuous ( $T_c = 100^{\circ}C$ )		22	А	
I <sub>DM</sub>	Drain Current	Pulsed	Pulsed (Note 1)		А	
E <sub>AS</sub>	Single Pulsed Avalanche	(Note 2)	1800	mJ		
I <sub>AR</sub>	Avalanche Current			12	А	
E <sub>AR</sub>	Repetitive Avalanche Energy			3.12	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			50	V/ns	
	MOSFET dv/dt Ruggedne	100				
P <sub>D</sub>	Davier Diagination	$(T_{C} = 25^{\circ}C)$		312	W	
	Power Dissipation	Derate above 25°C	Derate above 25°C		W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

### **Thermal Characteristics**

Symbol	Parameter	FCA36N60NF	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.40	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.24	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	

Device N	larking	Device	Packag	je	Reel Size	Таре	e Width		Quantit	у
		TO-3P	N	-		-		30		
Electrica	al Cha	racteristics								
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Chara	cteristic	cs								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		oltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V,T <sub>J</sub> = 25 <sup>o</sup> C		600	-	-	V	
∆BV <sub>DSS</sub>	Breakc	Breakdown Voltage Temperature					0.60		V/ºC	
$\Delta T_J$	Coeffic			$I_D = 1$ mA, Referenced to 25°C		-	0.60	-	V/°C	
I	Zero G	ate Voltage Drain Curr	ant	V <sub>DS</sub> =	= 480V, V <sub>GS</sub> = 0V		-	-	10	μA
DSS	SS Zero Gate Voltage Drain Current		UII	$T_J = 125^{\circ}C$		125°C	-	-	100	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current		ıt	$V_{GS} = \pm 30V, V_{DS} = 0V$		-	-	±100	nA	
On Chara	cteristic	°5								
V <sub>GS(th)</sub>		Threshold Voltage		Vcs =	= V <sub>DS</sub> , I <sub>D</sub> = 250μA		3.0	3.7	5.0	V
R <sub>DS(on)</sub>		Drain to Source On Res	sistance		= 10V, I <sub>D</sub> = 18A		-	80	95	mΩ
9FS		Forward Transconductance		$V_{DS} = 20V, I_D = 18A$		-	39	-	S	
	<b>0</b>			00						
-	Characteristics Input Capacitance							0404	10.15	
C <sub>iss</sub>		1		$V_{DS} = 100V, V_{GS} = 0V$ f = 1MHz		-	3191	4245	pF	
C <sub>oss</sub>		Capacitance				-	145	195	pF	
C <sub>rss</sub>		e Transfer Capacitance	9				-	5	8	pF
C <sub>oss</sub>		Output Capacitance		$V_{DS} = 380V, V_{GS} = 0V, f = 1MHz$		-	81	-	pF	
C <sub>oss</sub> eff.		ective Output Capacitance		$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$		-	338	-	pF	
Q <sub>g(tot)</sub>		ate Charge at 10V		V <sub>DS</sub> = 380V, I <sub>D</sub> = 18A, V <sub>GS</sub> = 10V (Note 4) Drain Open, f=1MHz		-	86	112	nC	
Q <sub>gs</sub>		Source Gate Charge				-	16	-	nC	
Q <sub>gd</sub>		Drain "Miller" Charge				-	36	-	nC	
ESR	Equiva	lent Series Resistance	(G-S)	Drain	Open, f=1MHz		-	1.2	-	Ω
Switching	Charac	cteristics								
t <sub>d(on)</sub>	Turn-O	n Delay Time		$V_{DD} = 380V, I_D = 18A$ $R_G = 4.7\Omega$ (Note 4)		-	27	64	ns	
t <sub>r</sub>	Turn-O	n Rise Time					-	17	44	ns
t <sub>d(off)</sub>	Turn-O	ff Delay Time					-	92	194	ns
t <sub>f</sub>	Turn-O	ff Fall Time				(Note 4)	-	4	18	ns
Drain-Sou	irce Dio	de Characteristic	S							
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current					-	-	36	А	
I <sub>SM</sub>	Maximu	um Pulsed Drain to Sou	rce Diode Fo			-	-	108	Α	
V <sub>SD</sub>		o Source Diode Forwar		$V_{GS} = 0V, I_{SD} = 18A$		-	-	1.2	V	
t <sub>rr</sub>		e Recovery Time	U U	$V_{GS} = 0V, I_{SD} = 18A$		-	166	-	ns	
Q <sub>rr</sub>	Revers	e Recovery Charge		$dI_F/dt = 100A/\mu s$		-	1.3	-	μC	

3.  $I_{SD} \leq$  36A, di/dt  $\leq$  1200A/µs,  $V_{DD} \leq$  380V, Starting  $T_J$  = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics

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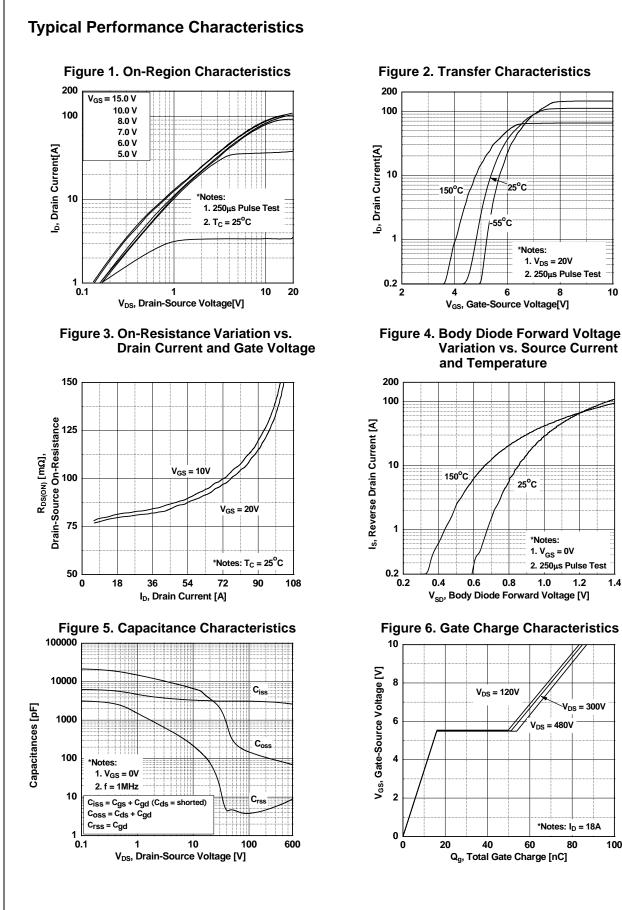
8

1.2

′<sub>DS</sub> = 300V

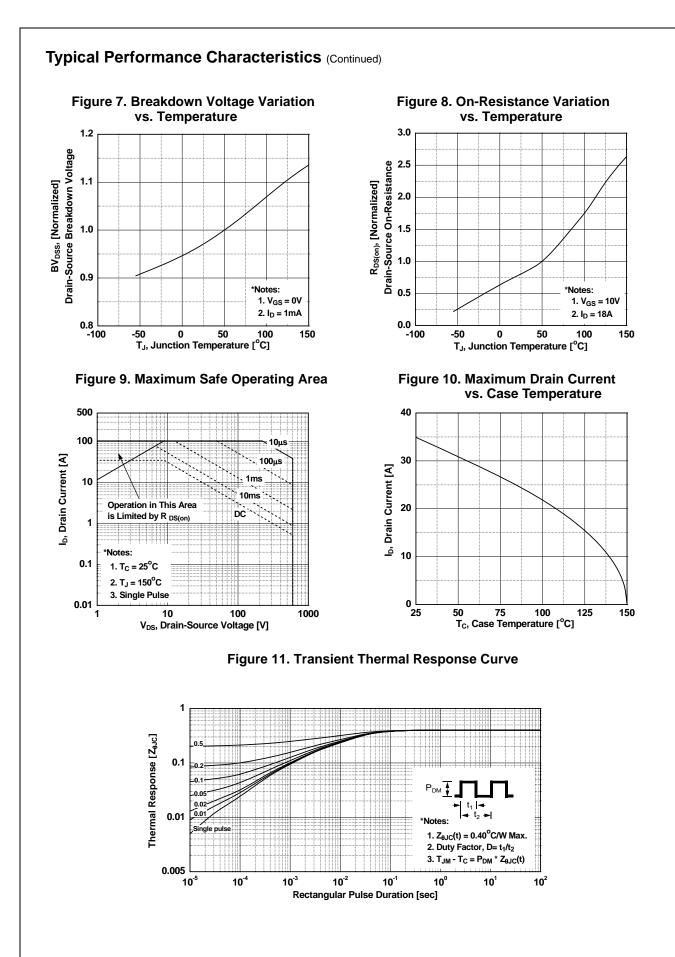
80

1.4

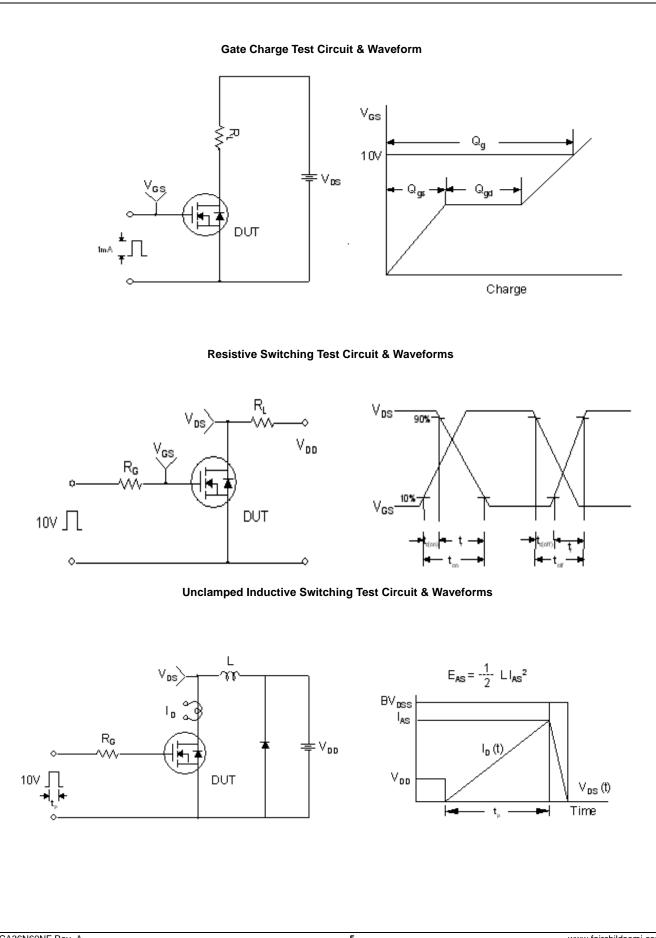


**Figure 2. Transfer Characteristics** 

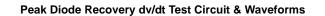
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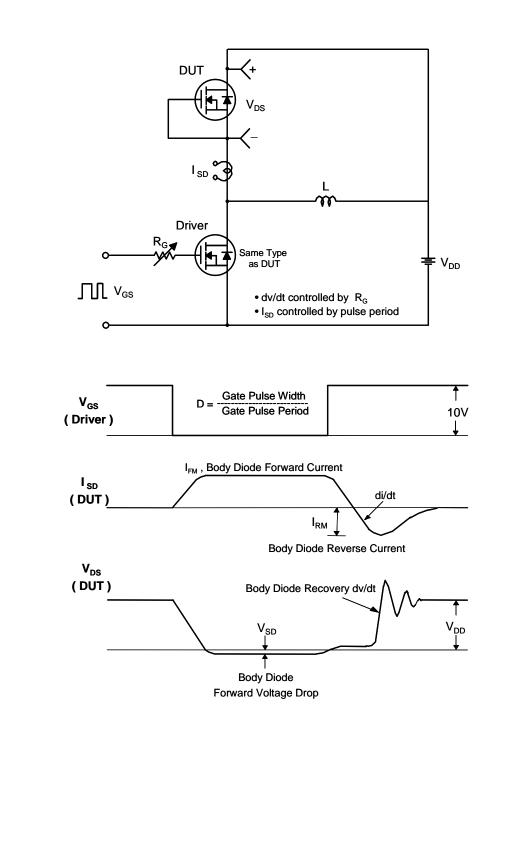


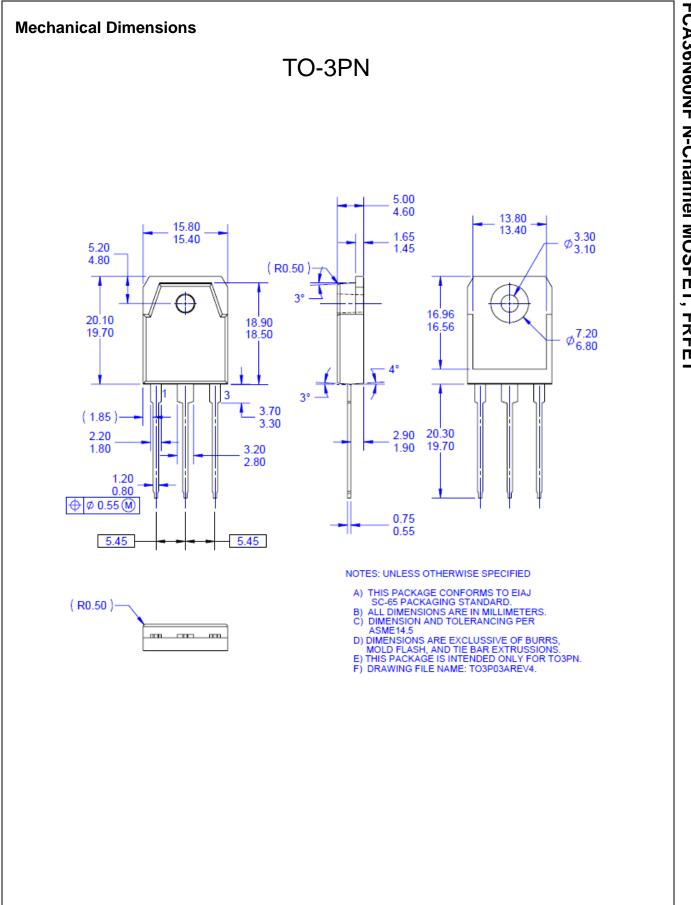
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